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## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



## TURBO 2 ULTRAFast HIGH VOLTAGE RECTIFIER

**Table 1: Main Product Characteristics**

$I_{F(AV)}$	Up to 2 x 40 A
$V_{RRM}$	600 V
$T_j$	175°C
$V_F$ (typ)	1.0 V
$t_{rr}$ (max)	65 ns

### FEATURES AND BENEFITS

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduces switching & conduction losses

### DESCRIPTION

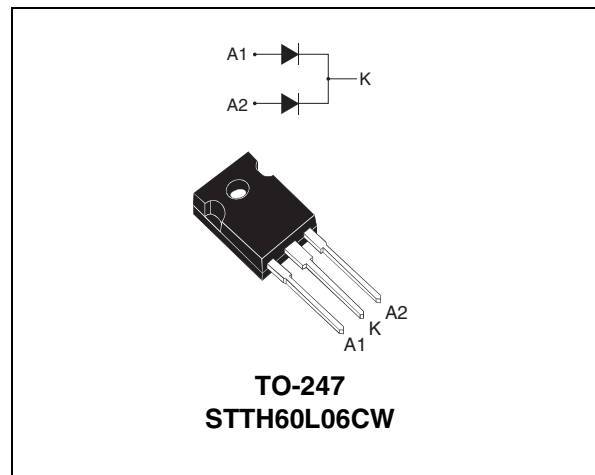
The STTH60L06, which is using ST Turbo 2 600V technology, is specially suited for use in switching power supplies, and industrial applications, as rectification and discontinuous mode PFC boost diode.

**Table 2: Order Codes**

Part Number	Marking
STTH60L06CW	STTH60L06CW

**Table 3: Absolute Ratings** (limiting values, per diode)

Symbol	Parameter		Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		600	V
$I_{F(RMS)}$	RMS forward current		60	A
$I_{F(AV)}$	Average forward current $\delta = 0.5$	$T_c = 125^\circ\text{C}$ Per diode	30	A
		$T_c = 110^\circ\text{C}$ Per device	60	
		$T_c = 100^\circ\text{C}$ Per diode	40	
		$T_c = 80^\circ\text{C}$ Per device	80	
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10\text{ms}$ sinusoidal	210	A
$T_{stg}$	Storage temperature range		-65 to + 175	°C
$T_j$	Maximum operating junction temperature		175	°C



**Table 4: Thermal Resistance**

Symbol	Parameter		Value (max).	Unit
$R_{th(j-c)}$	Junction to case	Per diode	1.05	°C/W
		Total	0.68	
$R_{th(c)}$	Coupling		0.3	°C/W

When the diodes 1 and 2 are used simultaneously:  
 $\Delta T_j(\text{diode } 1) = P(\text{diode } 1) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode } 2) \times R_{th(c)}$

**Table 5: Static Electrical Characteristics (per diode)**

Symbol	Parameter	Test conditions		Min.	Typ	Max.	Unit
$I_R^*$	Reverse leakage current	$T_j = 25^\circ\text{C}$	$V_R = V_{RRM}$			25	$\mu\text{A}$
		$T_j = 150^\circ\text{C}$			80	800	
$V_F^{**}$	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 30\text{A}$			1.55	V
		$T_j = 150^\circ\text{C}$			1.0	1.25	
		$T_j = 25^\circ\text{C}$	$I_F = 60\text{A}$			1.78	
		$T_j = 150^\circ\text{C}$			1.24	1.55	

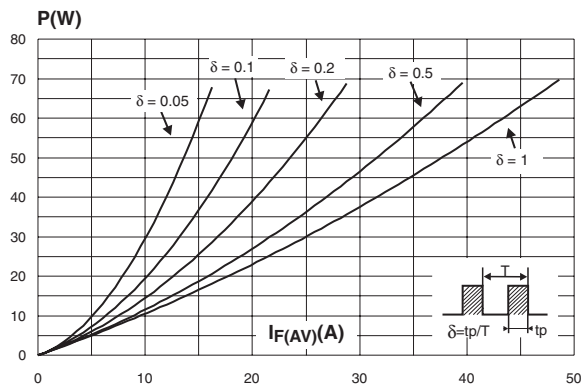
Pulse test: \*  $t_p = 5 \text{ ms}$ ,  $\delta < 2\%$   
 \*\*  $t_p = 380 \mu\text{s}$ ,  $\delta < 2\%$

To evaluate the conduction losses use the following equation:  $P = 0.95 \times I_{F(AV)} + 0.010 I_F^2(\text{RMS})$

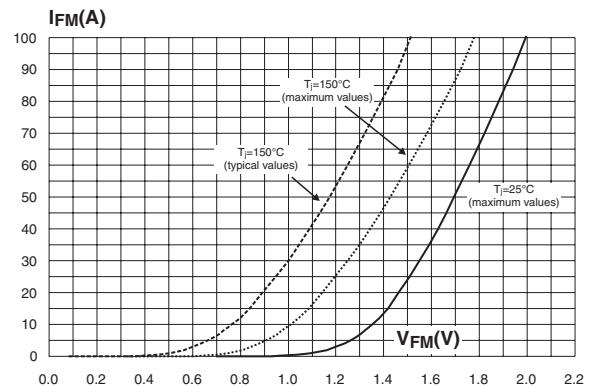
**Table 6: Dynamic Characteristics (per diode)**

Symbol	Parameter	Test conditions		Min.	Typ	Max.	Unit
$t_{rr}$	Reverse recovery time	$T_j = 25^\circ\text{C}$	$I_F = 0.5\text{A}$ $I_{rr} = 0.25\text{A}$ $I_R = 1\text{A}$			65	ns
			$I_F = 1\text{A}$ $di_F/dt = 50 \text{ A}/\mu\text{s}$ $V_R = 30\text{V}$		65	90	
$I_{RM}$	Reverse recovery current	$T_j = 125^\circ\text{C}$	$I_F = 30\text{A}$ $V_R = 400\text{V}$ $di_F/dt = 100 \text{ A}/\mu\text{s}$		11.5	16	A
$t_{fr}$	Forward recovery time	$T_j = 25^\circ\text{C}$	$I_F = 30\text{A}$ $di_F/dt = 100 \text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \times V_{Fmax}$			500	ns
$V_{FP}$	Forward recovery voltage	$T_j = 25^\circ\text{C}$	$I_F = 30\text{A}$ $di_F/dt = 100 \text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \times V_{Fmax}$		2.5		V

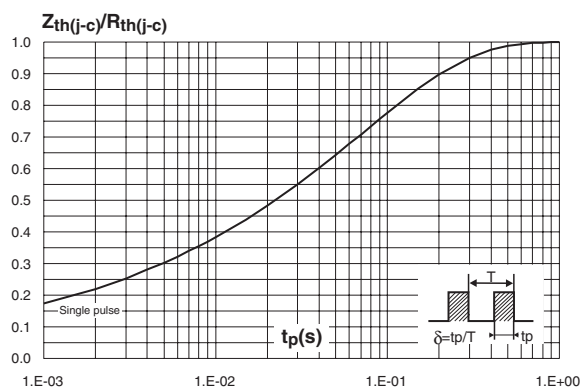
**Figure 1: Conduction losses versus average forward current (per diode)**



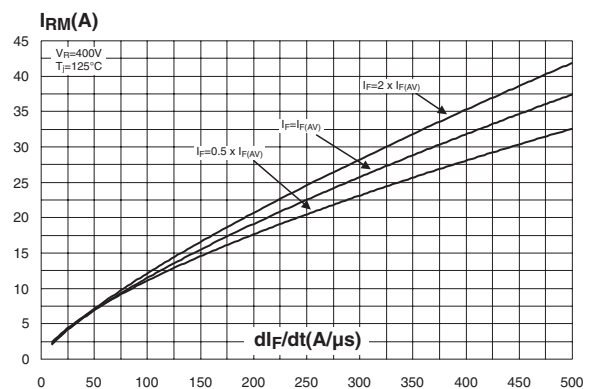
**Figure 2: Forward voltage drop versus forward current (per diode)**



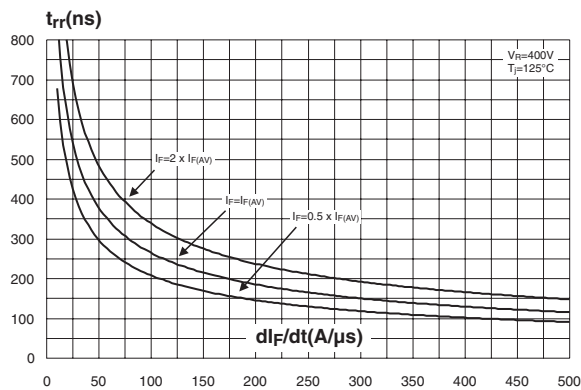
**Figure 3: Relative variation of thermal impedance junction to case versus pulse duration**



**Figure 4: Peak reverse recovery current versus diF/dt (typical values, per diode)**



**Figure 5: Reverse recovery time versus diF/dt (typical values, per diode)**



**Figure 6: Reverse recovery charges versus diF/dt (typical values, per diode)**

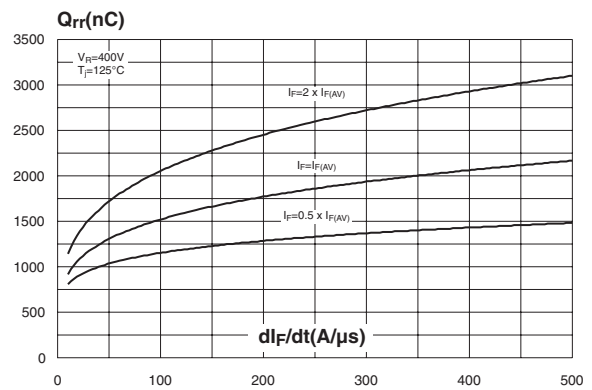




Figure 7: Reverse recovery softness factor versus  $di_F/dt$  (typical values, per diode)

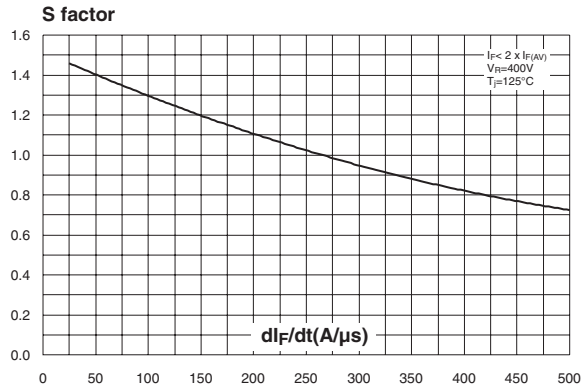


Figure 8: Relative variations of dynamic parameters versus junction temperature

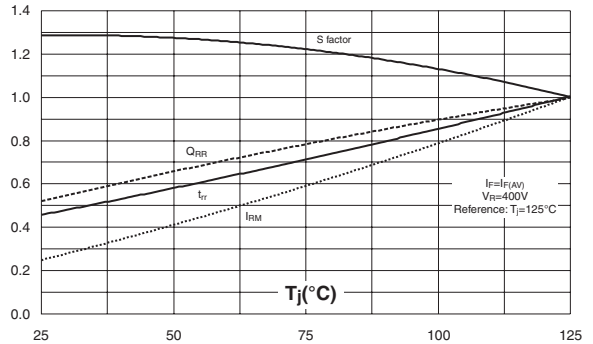


Figure 9: Transient peak forward voltage versus  $di_F/dt$  (typical values, per diode)

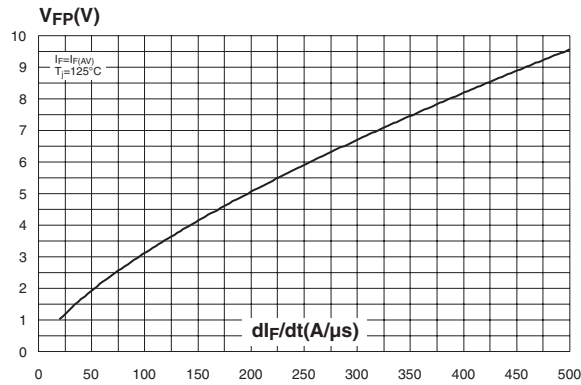


Figure 10: Forward recovery time versus  $di_F/dt$  (typical values, per diode)

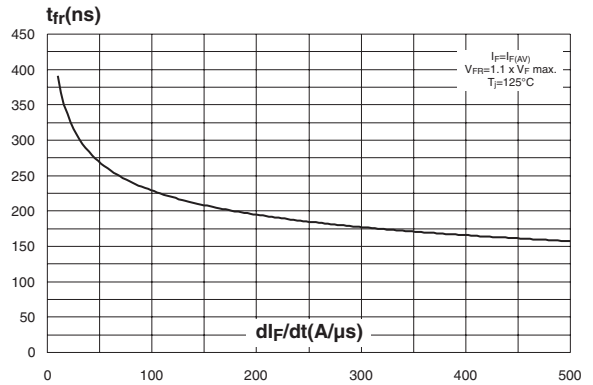


Figure 11: Junction capacitance versus reverse voltage applied (typical values, per diode)

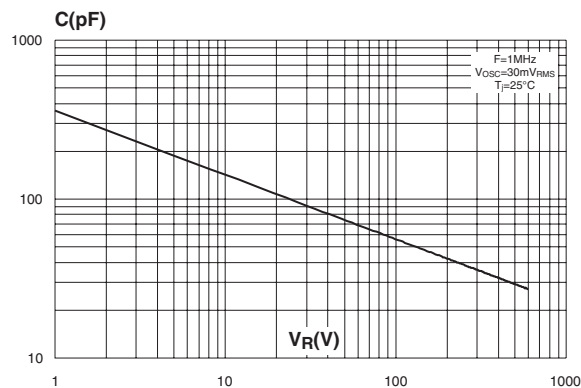


Figure 12: TO-247 Package Mechanical Data

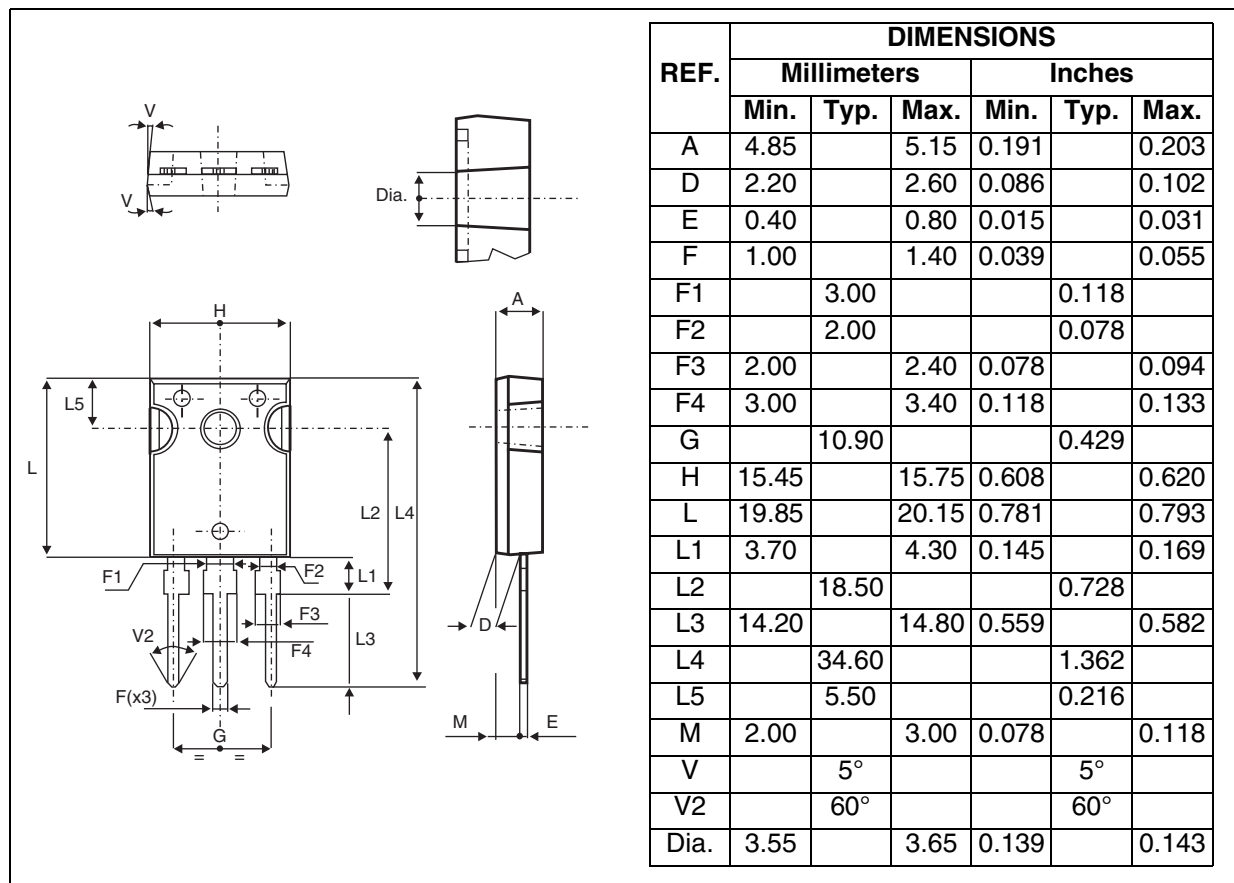


Table 7: Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTH60L06CW	STTH60L06CW	TO-247	4.46 g	50	Tube

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 m.N.
- Maximum torque value: 1.0 m.N.

Table 8: Revision History

Date	Revision	Description of Changes
07-Sep-2004	1	First issue

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